



HW B-

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Connell et al.

Serial No.: 10/082,372

Filed: February 25, 2002

For: WAFER BACK SIDE COATING TO
BALANCE STRESS FROM PASSIVATION
LAYER ON FRONT OF WAFER AND BE
USED AS A DIE ATTACH ADHESIVE

Confirmation No.: 1935

Examiner: A. Stevenson

Group Art Unit: 2812

Attorney Docket No.: 2269-5083US
(01-0428.00/US)

Notice of Allowance Mailed:

December 14, 2006

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

February 10, 2006
Date

Signature

Erika Gandre
Name (Type/Print)

TRANSMITTAL LETTER

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants submit herewith Part B - Fee(s) Transmittal for the above-captioned application. Also enclosed are Comments on Statement of Reasons for Allowance and Fee Addressee for Receipt of PTO Notices Relating to Maintenance Fees. On September 26, 2005, pursuant to a Notice of Allowance and Fee(s) Due dated June 29, 2005, Applicants submitted

Serial No. 10/082,372

Check No. 22144 in the amount of \$1,717.00 for issue fee, publication fee and five (5) copies of the patent when issued. On November 22, 2005, the above application was withdrawn from issue and a Request for Continued Examination (RCE) was filed along with a Supplemental Information Disclosure Statement. The application was again found allowable pursuant to a Notice of Allowance and Fee(s) Due dated December 14, 2005. Pursuant to the December 14, 2005 Notice of Allowance and Fee(s) Due, the fees were indicated to be \$0.00. **Applicants hereby request, pursuant to M.P.E.P. 1308.1, that the previously-paid Issue Fee and extra copies be applied to the issue fee currently due, as indicated by the \$0.00 balance set forth in the Notice of Allowance and Fee(s) Due.**

Applicants understand that no additional fees are required. However, if the Office determines that any comparison fees or other additional fees are required, the Commissioner is authorized to charge any such fees to TraskBritt Deposit Account No. 20-1469. A copy of this Transmittal Letter is enclosed for deposit account charging purposes.

Respectfully submitted,



James R. Duzan
Registration No. 28,393
Attorney for Applicants
TRASKBRITT
P.O. Box 2550
Salt Lake City, Utah 84110-2550
Telephone: 801-532-1922

Date: February 10, 2006

JRD/dlm:lmh

Enclosures: Part B - Issue Fee Transmittal

Copy of Transmittal Letter

Comments on Statement of Reasons for Allowance (2 pages)

Fee Addressee for Receipt of PTO Notices Relating to Maintenance Fees (2 pages)

Document in ProLaw



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Erika Gandre
Name (Type/Print)

COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

Mail Stop Issue Fee
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

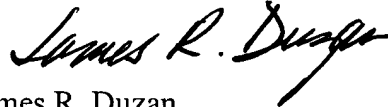
The Examiner indicates:

[While the prior art teaches a method for producing a non-warped semiconductor die; however, the prior art of record either singularly or in combination failed to anticipate or render obvious the limitations of applying a stress-balancing layer to a thinned wafer to balance stress caused by a front passivation layer.]

Applicants concur with the reasons as stated by the Examiner insofar as they comprise a summary, and are exemplary and not limiting. However, the independent claims as allowed

include other and different language than that specified by the Examiner, and the allowed dependent claims include other and further features and elements. Accordingly, the scope of the claims must be determined from the literal language of each as a whole, as well as equivalents thereof.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "James R. Duzan". The signature is fluid and cursive, with the first name "James" and last name "Duzan" clearly distinguishable.

James R. Duzan
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